Docket No.: SEC.556 FORM PTO-1595 (Modified) ΞT U.S. DEPARTMENT OF COMMERCE (Rev. 6-93) Patent and Trademark Office OMB No. 0651-0011 (exp.4/94) Copyright 1996-97 LegalStar P08A/REV02 Tab settings -To the Honorable Commissioner of Patents and Trademain attached original documents or copy thereof. 2. Name and address of receiving party(ies): 1. Name of conveying party(ies): LEE, Young-woo Name: Samsung Electronics Co., Ltd. Address: 416, Maetan-dong, Paldal-gu, ☐ Yes 🏻 No Additional names(s) of conveying party(ies) 3. Nature of conveyance: Assignment Merger City: Suwon-city, Kyungki-do State/Prov.: ☐ Change of Name ☐ Security Agreement ☐ Other _ Country: Republic of Korea ZIP: Execution Date: October 12, 1998 Additional name(s) & address(es) ☐ Yes X No 4. Application number(s) or registration numbers(s): If this document is being filed together with a new application, the execution date of the application is: October 12, 1998 Filing date Patent Application No. B. Patent No.(s) ☐ Yes 🛛 No Additional numbers 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: Name: SUSAN S. MORSE 7. Total fee (37 CFR 3.41):....\$ 40.00 Registration No. 35,292 Enclosed - Any excess or insufficiency should be credited or debited to deposit account Address: JONES & VOLENTINE, L.L.P. Authorized to be charged to deposit account 12200 SUNRISE VALLEY DRIVE, SUITE 150 8. Deposit account number: City: RESTON State/Prov.: VA 50-0238 ZIP: 20191 Country: U.S.A. <u>1/05/1998 DNGUYEN 00000037 09182199</u> DO NOT USE THIS SPACE 40,00 BP 1 FC:581 Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy

Signature

Total number of pages including cover sheet, attachments, and

of the original document.

Name of Person Signing

SUSAN S. MORSE

PATENT REEL: 9557 FRAME: 0357

OCT. 30, 1998

Date

JONES & VOLENTINE, L.L.P. (1/97)

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Young-woo LEE

and

Insert Name(s) of Inventor(s)

the undersigned hereby sell(s) and assign(s) to

SAMSUNG ELECTRONICS CO., LTD.

of 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea

Insert Name(s) of Assignee(s)

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

_

Address

SEMICONDUCTOR DEVICES HAVING DOUBLE PAD STRUCTURE, METHOD OF MANUFACTURING

THE SAME, AND SEMICONDUCTOR DEVICE PACKAGE FORMED THEREBY

for which an application for patent in the United States of America has been executed by the undersigned

Title of Invention

Date of Signing

of Application

on October 12, 1998

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

Page 1 of 2

				Office for recordation of this document undersigned name(s).
Date	_, Name of Inventor Jany No le			
Date				
	_, Name of Inventor			
Date				
least two witnesses who an Assignment even if i	sign here. Howe	cknowledged and/or r	recorded.)	on by the Inventor(s) be witnessed by a atent and Trademark Office is to record
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This	day of		, 19	_, before me
personally came the above-name	i			
o me personally known as the in executed the same of his (their) of	dividual(s) who own free will for	executed the foregoing the purposes therein	ng assignment, wh set forth.	o did acknowledge to me that he (they
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		Page 2 of 2		PATENT

RECORDED: 10/30/1998 REEL: 9557 FRAME: 0359